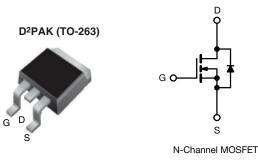
SiHB065N60E

Vishay Siliconix



E Series Power MOSFET



PRODUCT SUMMARY						
V _{DS} (V) at T _J max.	650					
R _{DS(on)} typ. (Ω) at 25 °C	$V_{GS} = 10 V$	0.057				
Q _g max. (nC)	74					
Q _{gs} (nC)	19					
Q _{gd} (nC)	15					
Configuration	Sing	le				

FEATURES

- 4th generation E series technology
- Low figure-of-merit (FOM) Ron x Qg
- Low effective capacitance (Co(er))
- Reduced switching and conduction losses
- Avalanche energy rated (UIS)
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

APPLICATIONS

- Server and telecom power supplies
- Switch mode power supplies (SMPS)
- Power factor correction power supplies (PFC)
- Lighting
 - High-intensity discharge (HID)
 - Fluorescent ballast lighting
- Industrial
 - Welding
 - Motor drives
 - Battery chargers
 - Solar (PV inverters)

ORDERING INFORMATION				
Package	D ² PAK (TO-263)			
Lead (Pb)-free and halogen-free	SiHB065N60E-GE3			
Lead (Pb)-free and halogen-free	SiHB065N60E-T1-GE3			

ABSOLUTE MAXIMUM RATINGS (T _C					
PARAMETER	SYMBOL	LIMIT	UNIT		
Drain-source voltage	V _{DS}	600	v		
Gate-source voltage	V _{GS}	± 30	v		
Continuous drain surrant $(T_{1} - 150 ^{\circ}\text{C})$	V _{GS} at 10 V	T _C = 25 °C T _C = 100 °C	- I _D	40	
Continuous drain current (T _J = 150 °C)	V _{GS} at 10 V	T _C = 100 °C		25	А
Pulsed drain current ^a	I _{DM}	116			
Linear derating factor			2	W/°C	
Single pulse avalanche energy ^b			E _{AS}	226	mJ
Maximum power dissipation	PD	250	W		
Operating junction and storage temperature range	T _J , T _{stg}	-55 to +150	°C		
Drain-source voltage slope	$T_{\rm J} = 1$	125 °C	d\//dt	100	1//22
Reverse diode dV/dt ^d		dV/dt	50	V/ns	
Soldering recommendations (peak temperature) ^c	10 s		260	°C	

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature

b. V_{DD} = 120 V, starting T_J = 25 °C, L = 28.2 mH, R_g = 25 $\Omega, \, I_{AS}$ = 4 A

c. 1.6 mm from case

d. $I_{SD} \leq I_D,\,dI/dt$ = 400 A/µs, starting T_J = 25 $^\circ C$

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COMPLIANT

HALOGEN

FREE



Vishay Siliconix

THERMAL RESISTANCE RATINGS							
PARAMETER	SYMBOL	TYP.	MAX.	UNIT			
Maximum junction-to-ambient	R _{thJA}	-	62	°C/W			
Maximum junction-to-case (drain)	R _{thJC}	-	0.5	C/W			

PARAMETER	R SYMBOL TEST CONDITIONS		T CONDITIONS	MIN.	TYP.	MAX.	UNIT
Static		•		•	•	•	
Drain-source breakdown voltage	V _{DS}	V _{GS} =	= 0 V, I _D = 250 μA	600	-	-	V
V _{DS} temperature coefficient	$\Delta V_{DS}/T_{J}$	Referenc	Reference to 25 °C, $I_D = 1 \text{ mA}$			-	V/°C
Gate-source threshold voltage (N)	V _{GS(th)}	V _{DS} =	V _{GS} , I _D = 250 μA	3	-	5	V
	I _{GSS}	$V_{GS} = \pm 20 V$		-	-	± 100	nA
Gate-source leakage		\	/ _{GS} = ± 30 V	-	-	± 1	μA
7	I _{DSS}	V _{DS} =	600 V, V _{GS} = 0 V	-	-	1	
Zero gate voltage drain current		V _{DS} = 480 V	-	-	10	μA	
Drain-source on-state resistance	R _{DS(on)}	$V_{GS} = 10 V$	I _D = 16 A	-	0.057	0.065	Ω
Forward transconductance	g _{fs}	V _{DS} :	= 20 V, I _D = 16 A	-	12	-	S
Dynamic		·					
Input capacitance	C _{iss}		V _{GS} = 0 V,	-	2700	-	
Output capacitance	C _{oss}	· ·	V _{DS} = 100 V,	-	102	-	
Reverse transfer capacitance	C _{rss}		f = 1 MHz	-	5	-	
Effective output capacitance, energy related ^a	C _{o(er)}		$V_{DS} = 0 V$ to 480 V, $V_{GS} = 0 V$		93	-	pF
Effective output capacitance, time related ^b	C _{o(tr)}	$v_{\rm DS} = 0.0$			593	-	
Total gate charge	Qg			-	49	74	
Gate-source charge	Q _{gs}	$V_{GS} = 10 V$	I _D = 16 A, V _{DS} = 480 V	-	19	-	nC
Gate-drain charge	Q _{gd}			-	15	-	
Turn-on delay time	t _{d(on)}			-	28	56	
Rise time	t _r	V _{DD} =	480 V, I _D = 16 A,	-	46	92	
Turn-off delay time	t _{d(off)}	V _{GS} =	= 10 V, R _g = 9.1 Ω	-	54	108	ns
Fall time	t _f			-	13	26	
Gate input resistance	Rg	f = 1	MHz, open drain	0.3	0.7	1.4	Ω
Drain-Source Body Diode Characteristic	s	<u>.</u>					
Continuous source-drain diode current	I _S	MOSFET sym showing the	bol	-	-	40	
Pulsed diode forward current	I _{SM}	integral revers p - n junction		-	-	116	A
Diode forward voltage	V _{SD}	T _J = 25 °C	C, I _S = 16 A, V _{GS} = 0 V	-	-	1.2	V
Reverse recovery time	t _{rr}			-	382	764	ns
Reverse recovery charge	Q _{rr}		5 °C, I _F = I _S = 16 A, 00 A/μs, V _B = 400 V	-	7.1	14.2	μC
Reverse recovery current	I _{BBM}	ai/at = 1	-	34	-	A	

Notes

a. $C_{oss(er)}$ is a fixed capacitance that gives the same energy as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DSS}

b. Coss(tr) is a fixed capacitance that gives the same charging time as Coss while VDS is rising from 0 % to 80 % VDSS

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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

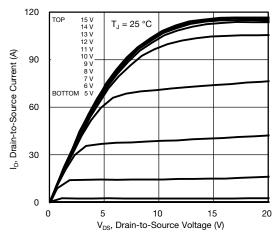
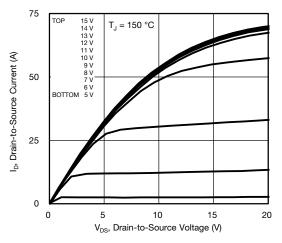


Fig. 1 - Typical Output Characteristics





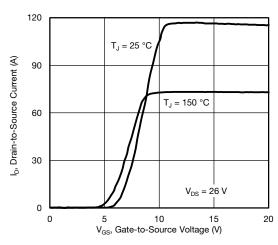


Fig. 3 - Typical Transfer Characteristics

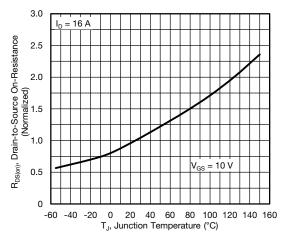


Fig. 4 - Normalized On-Resistance vs. Temperature

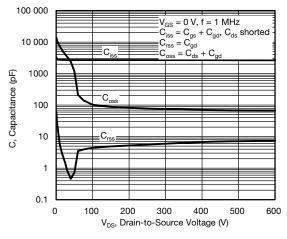


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

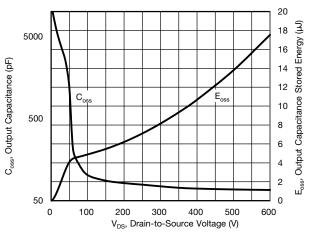


Fig. 6 - C_{oss} and E_{oss} vs. V_{DS}

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SiHB065N60E

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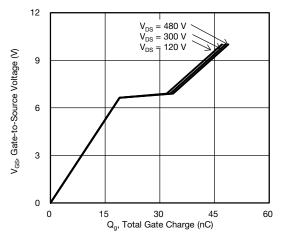


Fig. 7 - Typical Gate Charge vs. Gate-to-Source Voltage

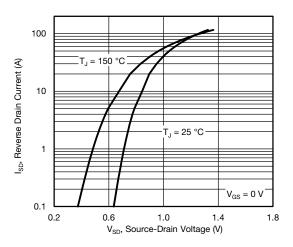


Fig. 8 - Typical Source-Drain Diode Forward Voltage

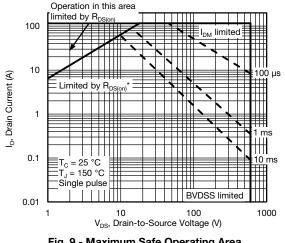


Fig. 9 - Maximum Safe Operating Area

Note

a. V_{GS} > minimum V_{GS} at which $R_{DS(on)}$ is specified

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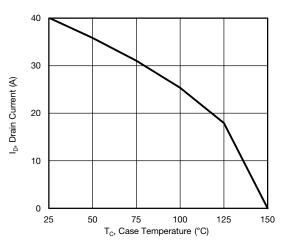


Fig. 10 - Maximum Drain Current vs. Case Temperature

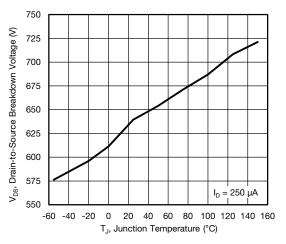
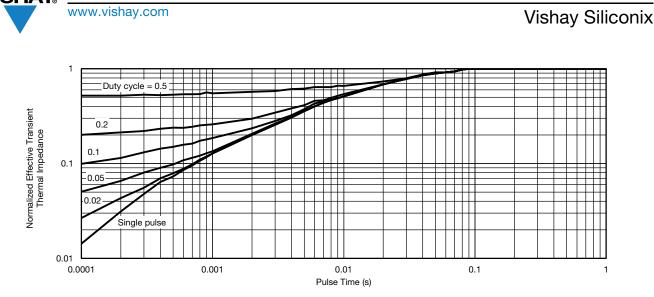


Fig. 11 - Temperature vs. Drain-to-Source Voltage





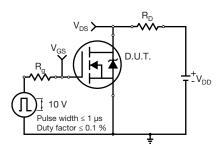


Fig. 13 - Switching Time Test Circuit

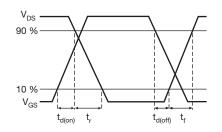


Fig. 14 - Switching Time Waveforms

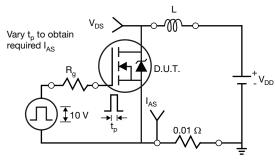


Fig. 15 - Unclamped Inductive Test Circuit

SiHB065N60E

Fig. 16 - Unclamped Inductive Waveforms

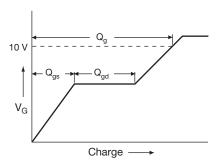


Fig. 17 - Basic Gate Charge Waveform

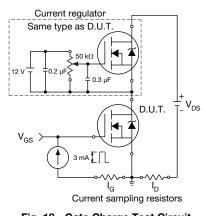


Fig. 18 - Gate Charge Test Circuit

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Peak Diode Recovery dv/dt Test Circuit

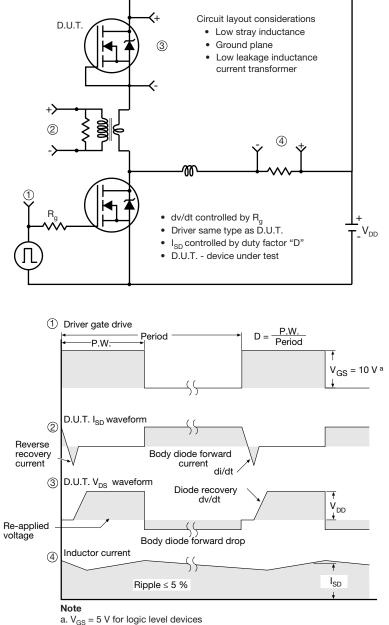


Fig. 19 - For N-Channel

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H

A1

B

Gauge plane

L3

Detail "A" Rotated 90° CW scale 8:1

0° to 8° **Vishay Siliconix**

Seating plane

TO-263AB (HIGH VOLTAGE)

/3 ⁄4 A

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Detail A

(Datum A)

D

 $\underline{4}$ 11

	2	-	Y 2 x b2 2 x b ⊕ 0.010 @ A(■ ating 5 b1, b b1, b b1, b c) c) c) c) c) c) c) c) c) c)	$\begin{array}{c} c_{1} \\ c_{1} \\ c_{2} \\ c_{3} \\ c_{4} \\ c_{5} \\ c_{5} \\ c_{7} \\$	a - 1		Ū.	1 <u>4</u>	
	MILLIN	IETERS	INCHES				MILLIMETERS		INCHES	
DIM.	MIN.	MAX.	MIN.	MAX.		DIM.	MIN.	MAX.	MIN.	MAX.
А	4.06	4.83	0.160	0.190		D1	6.86	-	0.270	-
				0.010		-		10.07	0.000	0.420
A1	0.00	0.25	0.000	0.010		E	9.65	10.67	0.380	0.120
A1 b	0.00 0.51	0.25 0.99	0.000	0.010		E1	9.65 6.22	- 10.67	0.380	-
							6.22	- 10.67 - BSC	0.245	- BSC
b	0.51	0.99	0.020	0.039		E1	6.22	-	0.245	-
b b1	0.51 0.51	0.99 0.89	0.020 0.020	0.039 0.035		E1 e	6.22 2.54	- BSC	0.245	-) BSC
b b1 b2	0.51 0.51 1.14	0.99 0.89 1.78	0.020 0.020 0.045	0.039 0.035 0.070		E1 e H	6.22 2.54 14.61	- BSC 15.88	0.245 0.100 0.575	-) BSC 0.625
b b1 b2 b3	0.51 0.51 1.14 1.14	0.99 0.89 1.78 1.73	0.020 0.020 0.045 0.045	0.039 0.035 0.070 0.068		E1 e H L	6.22 2.54 14.61 1.78	- BSC 15.88 2.79	0.245 0.100 0.575 0.070	- 0 BSC 0.625 0.110
b b1 b2 b3 c	0.51 0.51 1.14 1.14 0.38	0.99 0.89 1.78 1.73 0.74	0.020 0.020 0.045 0.045 0.015	0.039 0.035 0.070 0.068 0.029		E1 e H L L1	6.22 2.54 14.61 1.78 - -	- BSC 15.88 2.79 1.65	0.245 0.100 0.575 0.070 - -	- 0 BSC 0.625 0.110 0.066
b b1 b2 b3 c c1	0.51 0.51 1.14 1.14 0.38 0.38	0.99 0.89 1.78 1.73 0.74 0.58	0.020 0.020 0.045 0.045 0.015 0.015	0.039 0.035 0.070 0.068 0.029 0.023		E1 e H L L1 L2	6.22 2.54 14.61 1.78 - -	- BSC 15.88 2.79 1.65 1.78	0.245 0.100 0.575 0.070 - -	- 0 BSC 0.625 0.110 0.066 0.070

Α

Notes

1. Dimensioning and tolerancing per ASME Y14.5M-1994.

2. Dimensions are shown in millimeters (inches).

3. Dimension D and E do not include mold flash. Mold flash shall not exceed 0.127 mm (0.005") per side. These dimensions are measured at the outmost extremes of the plastic body at datum A.

4. Thermal PAD contour optional within dimension E, L1, D1 and E1.

5. Dimension b1 and c1 apply to base metal only.

6. Datum A and B to be determined at datum plane H.

7. Outline conforms to JEDEC outline to TO-263AB.



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RECOMMENDED MINIMUM PADS FOR D²PAK: 3-Lead



Recommended Minimum Pads Dimensions in Inches/(mm)

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